

HCG600FH120D3E1

1200V / 600A D3 (size similar to Econo Dual with Cu Baseplate)

Features

- LOW $V_{CE(SAT)}$
- $V_{CE(SAT)}$ with positive temperature coefficient

Applications

- Inverter for motor drives AC and DC servo drives
- High power converters
- UPS systems



Table 1 Key Performance and Package Parameters

Type	V_{CE}	I_C ($T_C = 85^\circ\text{C}$)	$V_{CE(SAT)}$ ($T_{vj} = 25^\circ\text{C}$, $I_C = 600\text{A}$, $V_{GE} = 15\text{V}$)	T_{vjmax}	Package
IGBT	1200V	600A	1.59 V	175°C	D3

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Table 2 Absolute Maximum Ratings

Parameter	Symbol	Conditions	Value	Unit
Collector emitter voltage	V_{CE}	$T_{vj} = 25^{\circ}\text{C}$	1200	V
Continuous DC collector current	I_{CDC}	$T_C = 85^{\circ}\text{C}$	600	A
Repetitive peak collector current	I_{CRM}	$T_p=1\text{ms}$	1200	
Continuous DC forward Current	I_F		600	A
Repetitive peak forward current	I_{FRM}	$T_p=1\text{ms}$	1200	A
I^2t -value	I^2t	$T_p=10\text{ms}, V_R=0\text{V}, T_{vj} = 175^{\circ}\text{C}$	40000	A^2S
Gate Emitter voltage	V_{GE}	$T_{vj} = 25^{\circ}\text{C}$	± 20	V
Junction temperature	T_{vj}		-40 to +175	$^{\circ}\text{C}$
Storage temperature	T_{stg}		-40 to +125	
Operating virtual junction temperature	T_{vjop}		150	$^{\circ}\text{C}$

Table 3 Thermal Resistance

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
IGBT Thermal resistance junction - case	R_{thJC}	Per IGBT	-	0.069	-	$^{\circ}\text{C} / \text{W}$
IGBT Thermal resistance case - heatsink	R_{thCH}	Thermal grease, $\lambda_{grease} = 0.67 \text{ W}/(\text{m}^{\circ}\text{K})$	-	0.062		$^{\circ}\text{C} / \text{W}$
Diode Thermal resistance junction - case	R_{thJC}	Per diode	-	0.094	-	$^{\circ}\text{C} / \text{W}$
Diode Thermal resistance case - heatsink	R_{thCH}	Thermal grease, $\lambda_{grease} = 0.67 \text{ W}/(\text{m}^{\circ}\text{K})$	-	0.059	-	$^{\circ}\text{C} / \text{W}$

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Table 4 Static Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector emitter voltage	$V_{(BR)CES}$	$T_{vj} = 25^{\circ}\text{C}$	1200	-	-	V
Collector emitter saturation voltage	V_{CEsat} (terminal)	$V_{GE} = 15\text{V}, I_C = 600\text{A}$ $T_{vj} = 25^{\circ}\text{C}$	-	1.59	-	V
		$V_{GE} = 15\text{V}, I_C = 600\text{A}$ $T_{vj} = 175^{\circ}\text{C}$	-	1.89	-	
	V_{CEsat} (chip)	$V_{GE} = 15\text{V}, I_C = 600\text{A},$ $T_{vj} = 175^{\circ}\text{C}$	-	1.78	-	
Diode forward voltage	V_F (terminal)	$V_{GE} = 0\text{V}, I_C = 600\text{A}$ $T_{vj} = 25^{\circ}\text{C}$	-	1.74	-	V
		$V_{GE} = 0\text{V}, I_C = 600\text{A}$ $T_{vj} = 175^{\circ}\text{C}$	-	1.89	-	
	V_F (chip)	$V_{GE} = 0\text{V}, I_C = 600\text{A},$ $T_{vj} = 175^{\circ}\text{C}$	-	1.78	-	
Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}, I_C = 12\text{mA}$	-	5.8	-	V
Zero gate voltage collector current	I_{CES}	$V_{CE} = 1200\text{V}, V_{GE} = 0\text{V}$ $T_{vj} = 25^{\circ}\text{C}$	-	-	100	μA
Gate-emitter leakage current	I_{GES}	$V_{GE} = 20\text{V}, V_{CE} = 0\text{V}$	-	-	100	nA
Input capacitance	C_{ies}	$V_{GS} = 0\text{V}$ $V_{DS} = 25\text{V}$ $f = 100\text{kHz}$	-	83.6	-	nF
Output capacitance	C_{oes}		-	2.4	-	
Reverse transfer capacitance	C_{res}		-	0.5	-	
Gate input resistance	R_G	$f = 1\text{M Hz}$	-	0.48	-	Ω
Gate charge	Q_G	$V_{GE} = -15\text{V to } 15\text{V}$ $V_{CE} = 600\text{V}$	-	4.0	-	μC

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Table 5 Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Turn-on delay time	t_{don}	$T_{vj} = 25^{\circ}\text{C}$, $V_{CC} = 600\text{V}$, $I_C = 600\text{A}$, $V_{GE} = -15/15\text{V}$, $R_{G(on)}=0.51\Omega, R_{G(off)}= 0.51\Omega$	-	220	-	ns
Rise time	t_r		-	75	-	
Turn-off delay time	t_{doff}		-	440	-	
Fall time	t_f		-	158	-	
Turn-on energy	E_{on}		-	31	-	mJ
Turn-off energy	E_{off}		-	64	-	
Total switching energy	E_{ts}		-	95	-	
Turn-on delay time	t_{don}	$T_{vj} = 175^{\circ}\text{C}$, $V_{CC} = 600\text{V}$, $I_C = 600\text{A}$, $V_{GE} = -15/15\text{V}$, $R_{G(on)}= 0.51\Omega, R_{G(off)}= 0.51\Omega$	-	378	-	ns
Rise time	t_r		-	99	-	
Turn-off delay time	t_{doff}		-	583	-	
Fall time	t_f		-	373	-	
Turn-on energy	E_{on}		-	69	-	mJ
Turn-off energy	E_{off}		-	96	-	
Total switching energy	E_{ts}		-	165	-	
Short circuit current	I_{SC}	$T_{vj} = 175^{\circ}\text{C}$, $V_{CC} = 800\text{V}, V_{GE} = 15\text{V}$, $V_{CEmax} = V_{CES} - L_{sCE} * di/dt$ $T_P \leq 6 \text{ us}$	-	1800	-	A

Table 6 Diode Recovery Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Reverse recovery time	T_{rr}	$T_{vj} = 25^{\circ}\text{C}$, $V_{CC} = 600\text{V}$, $I_C = 600\text{A}$, $V_{GE} = -15/15\text{V}$, $R_{G(on)} = 0.51\Omega, R_{G(off)} = 0.51\Omega$	-	300	-	ns
Peak reverse recovery current	I_{rr}		-	400	-	A
Reverse recovery charge	Q_{rr}		-	48	-	μC
Reverse recovery energy	E_{rec}		-	19	-	mJ
Reverse recovery time	T_{rr}	$T_{vj} = 175^{\circ}\text{C}$, $V_{CC} = 600\text{V}$, $I_C = 600\text{A}$, $V_{GE} = -15/15\text{V}$, $R_{G(on)} = 0.51\Omega, R_{G(off)} = 0.51\Omega$	-	630	-	ns
Peak reverse recovery current	I_{rr}		-	360	-	A
Reverse recovery charge	Q_{rr}		-	113	-	μC
Reverse recovery energy	E_{rec}		-	40	-	mJ

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Table 7 Module Characteristics

Parameter	Symbol	Conditions	Value	Unit
Isolation test voltage	V_{ISOL}	RMS, $f = 50 \text{ Hz}$, $t = 1\text{min}$	3.4	kV
Material of module baseplate			Cu+Ni	
Internal isolation		Basic insulation	Al_2O_3	
Creepage distance	d_{Creep}	terminal to heatsink	14.5	mm
Creepage distance	d_{Creep}	terminal to terminal	12	mm
Clearance	d_{Clear}	terminal to heatsink	11.5	mm
Clearance	d_{Clear}	terminal to terminal	10	mm
Mounting torque of screws to heat sink	M_s	M5	3.0-6.0	N·m
Mounting torque of screws to terminals	M_t	M6	3.0-6.0	N·m
Comparative tracking index	CTI		>175	

Table 8 NTC-Thermistor

Parameter	Symbol	Conditions	Min	Typ.	Max	Unit
Rated resistance	R_{25}	$T_{NTC} = 25^\circ\text{C}$	-	5	-	k Ω
Deviation of R_{100}	$\Delta R/R$	$T_{NTC} = 100^\circ\text{C}$, $R_{100} = 493 \Omega$	-5	-	5	%
B-value	$B_{25/50}$	$R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298,15K))]$	-	3375	-	K

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Characteristics Diagrams

Fig.1 Typical Output Characteristic, IGBT, Inverter
 $I_C = f(V_{CE})$ / (terminal)
 $V_{GE} = 15V$
 $T_{vj} = 25^\circ C$

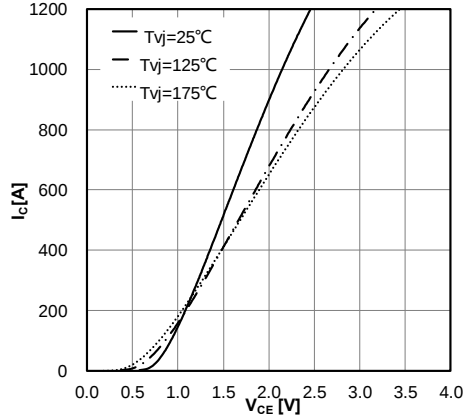


Fig.2 Typical Output Characteristic, IGBT, Inverter
 $I_C = f(V_{CE})$ / (terminal)
 $T_{vj} = 175^\circ C$

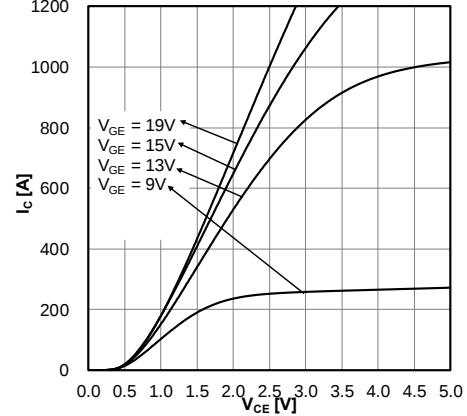


Fig.3 Typical Output Characteristic, IGBT, Inverter
 $I_C = f(V_{GE})$
 $V_{CE} = 20V$

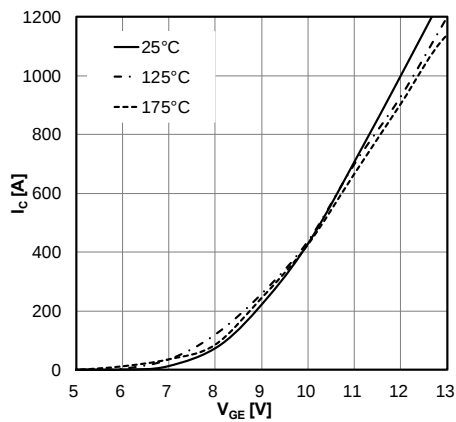


Fig.4 Switching losses, IGBT, Inverter
 $E = f(I_C)$

$R_{Goff} = 0.51\Omega$, $R_{Gon} = 0.51\Omega$, $V_{CE} = 600V$, $V_{GE} = \pm 15V$

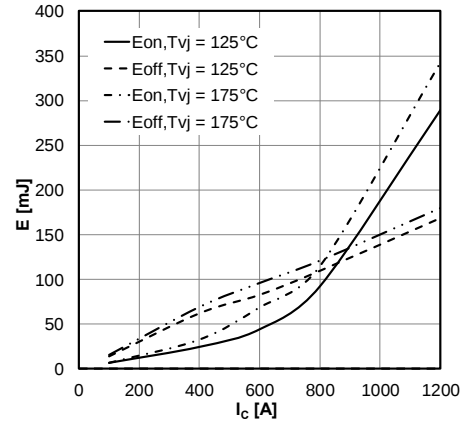


Fig.5 Switching losses, IGBT, Inverter
 $E = f(R_G)$
 $I_C = 600A$, $V_{CE} = 600V$, $V_{GE} = \pm 15V$

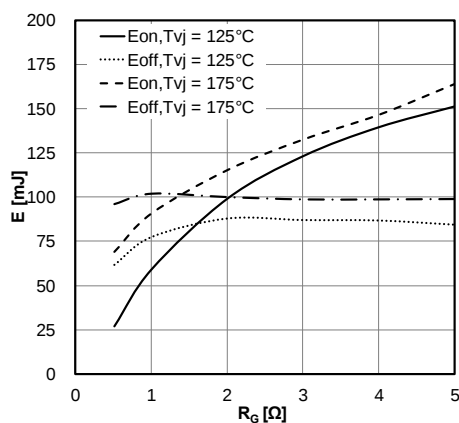
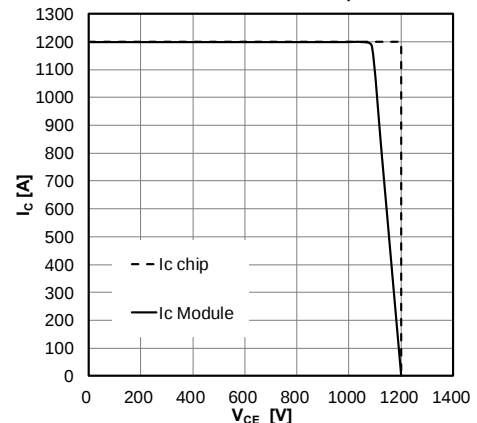


Fig.6 Reverse bias safe operating area (RBOSA), IGBT, Inverter

$I_C = f(V_{CE})$

$R_{Goff} = 0.51\Omega$, $V_{GE} = \pm 15V$, $T_{vj} = 175^\circ C$



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Characteristics Diagrams

Fig.7 Capacity characteristic, IGBT, Inverter
 $C = f(V_{CE})$

$f = 100 \text{ KHz}$, $V_{GE} = 0V$, $T_{vj} = 25^\circ\text{C}$

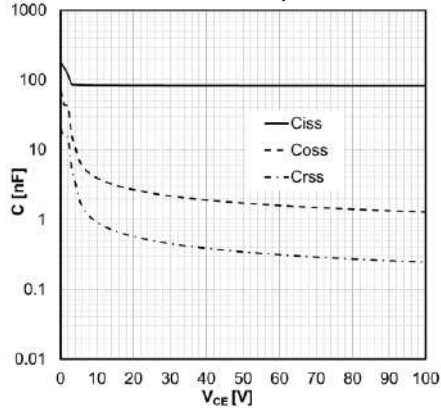


Fig.8 Temperature characteristic, NTC - Thermistor

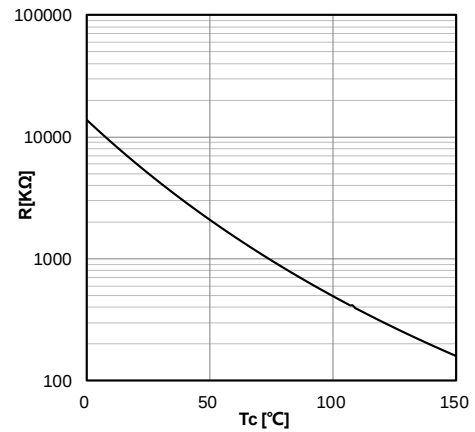


Fig.9 Forward characteristic, Diode, Inverter
 $I_F = f(V_F) / (\text{terminal})$

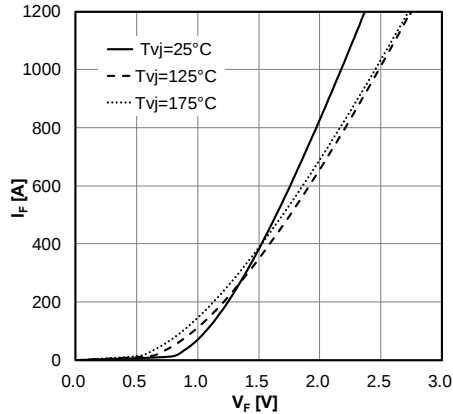


Fig.10 Switching losses, Diode, Inverter
 $E_{rec} = f(I_F)$

$V_{CE} = 600V$, $R_{Goff} = 0.51\Omega$, $R_{Gon} = 0.51\Omega$, $V_{GE} = \pm 15V$

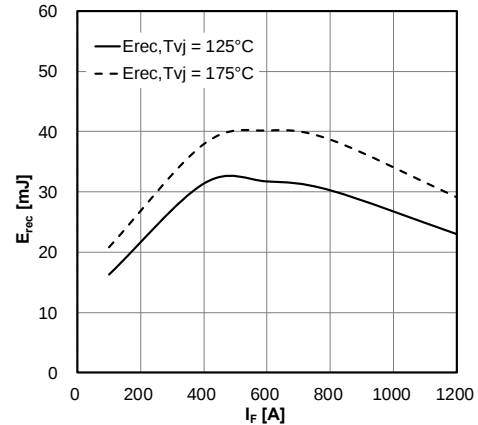
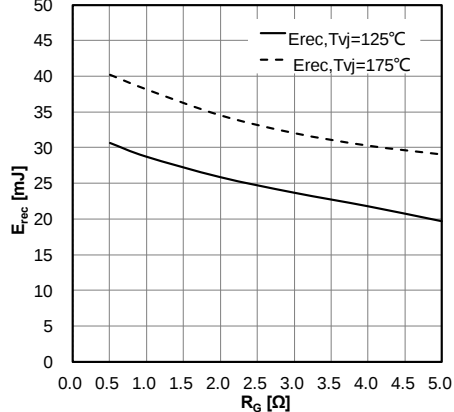


Fig.11 Switching losses, Diode, Inverter
 $E_{rec} = f(R_G)$

$V_{CE} = 600V$, $I_F = 600A$



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Characteristics Diagrams

Fig.12 Transient thermal impedance IGBT, Inverter
 $Z_{thJC} = f(t)$

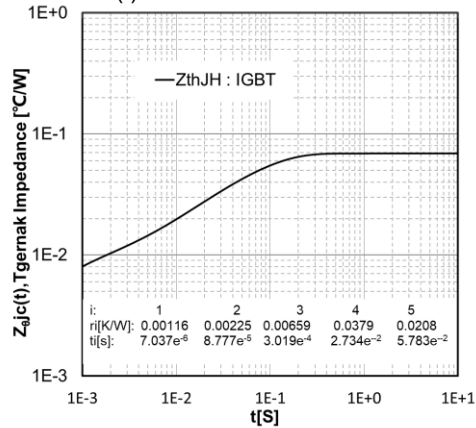
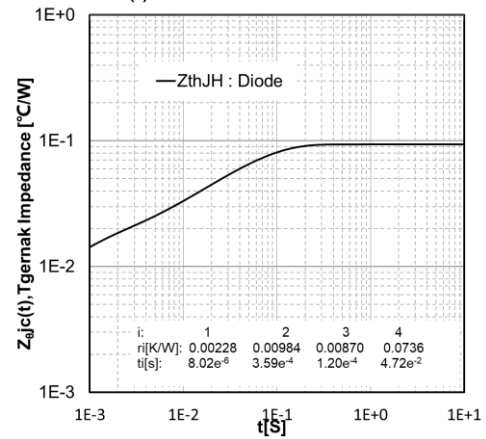


Fig.13 Transient thermal impedance Diode, Inverter
 $Z_{thJC} = f(t)$

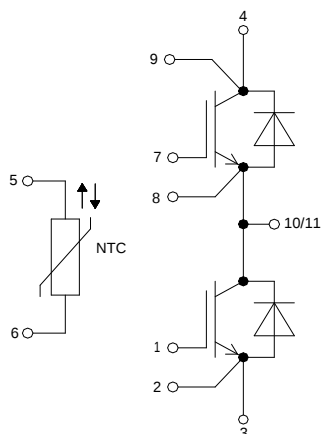


HCG600FH120D3E1

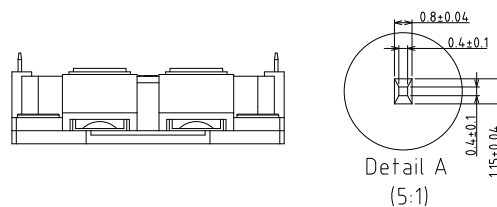
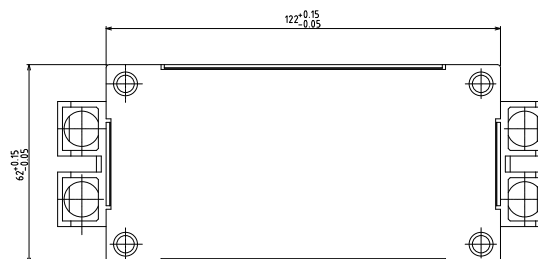
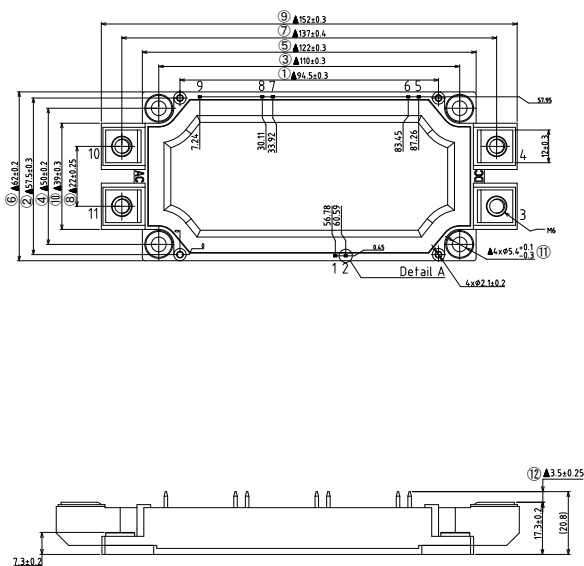
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Package Information

Circuit Diagram



Package Outlines



Revision History

Document Version	Description of Changes
RevX.0.1	Released

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